# SN54AC374, SN74AC374 OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

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- 2-V to 6-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 6 V
- Max t<sub>pd</sub> of 9.5 ns at 5 V
- 3-State Noninverting Outputs Drive Bus Lines Directly
- Full Parallel Access for Loading

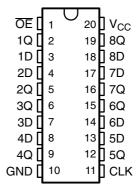
#### description/ordering information

These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. The devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

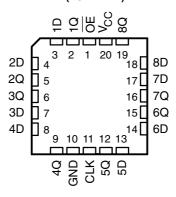
The eight flip-flops of the 'AC374 devices are D-type edge-triggered flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines in bus-organized systems without need for interface or pullup components.

SN54AC374 . . . J OR W PACKAGE SN74AC374 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



## SN54AC374 . . . FK PACKAGE (TOP VIEW)



OE does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

#### **ORDERING INFORMATION**

| T <sub>A</sub> | PACKAG     | Ε <sup>†</sup> | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|------------|----------------|--------------------------|---------------------|
|                | PDIP – N   | Tube           | SN74AC374N               | SN74AC374N          |
|                | 0010 PW    | Tube           | SN74AC374DW              | 10074               |
| –40°C to 85°C  | SOIC – DW  | Tape and reel  | SN74AC374DWR             | AC374               |
|                | SOP - NS   | Tape and reel  | SN74AC374NSR             | AC374               |
|                | SSOP – DB  | Tape and reel  | SN74AC374DBR             | AC374               |
|                | TOCOD DW   | Tube           | SN74AC374PW              | 10074               |
|                | TSSOP – PW | Tape and reel  | SN74AC374PWR             | AC374               |
|                | CDIP – J   | Tube           | SNJ54AC374J              | SNJ54AC374J         |
| -55°C to 125°C | CFP – W    | Tube           | SNJ54AC374W              | SNJ54AC374W         |
|                | LCCC - FK  | Tube           | SNJ54AC374FK             | SNJ54AC374FK        |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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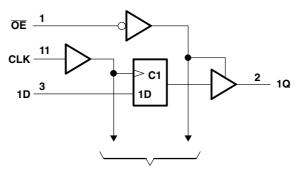
#### description/ordering information (continued)

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## FUNCTION TABLE (each flip-flop)

|    | INPUTS     |   | OUTPUT |
|----|------------|---|--------|
| ŌĒ | CLK        | D | Q      |
| L  | <b>↑</b>   | Н | Н      |
| L  | $\uparrow$ | L | L      |
| L  | H or L     | Χ | $Q_0$  |
| Н  | X          | Χ | Z      |

#### logic diagram (positive logic)



To Seven Other Channels

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|   |              | · · · · · · · · · · · · · · · · · · ·        |
|---|--------------|--|
| Supply voltage range, V <sub>CC</sub>                         |              | –0.5 V to 7 V                                |
| Input voltage range, V <sub>I</sub> (see Note 1)              |              | . $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Output voltage range, V <sub>O</sub> (see Note 1)             |              | . $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) |              | ±20 mA                                       |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CO}$  |              |  |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )    |              |  |
| Continuous current through V <sub>CC</sub> or GND             |              | ±200 mA                                      |
| Package thermal impedance, $\theta_{JA}$ (see Note 2):        | : DB package | 70°C/W                                       |
|   | DW package   | 58°C/W                                       |
|   | N package    | 69°C/W                                       |
|   | NS package   | 60°C/W                                       |
|   | PW package   | 83°C/W                                       |
| Storage temperature range, $T_{stg}\dots\dots$                |              | –65°C to 150°C                               |
|   |              |  |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



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#### recommended operating conditions (see Note 3)

|                 |                                    |                         | SN54A | C374     | SN74A | C374     |      |
|-----------------|------------------------------------|-------------------------|-------|----------|-------|----------|------|
|                 |                                    |                         | MIN   | MAX      | MIN   | MAX      | UNIT |
| V <sub>CC</sub> | Supply voltage                     |                         | 2     | 6        | 2     | 6        | V    |
|                 |                                    | V <sub>CC</sub> = 3 V   | 2.1   |          | 2.1   |          |      |
| $V_{IH}$        | High-level input voltage           | V <sub>CC</sub> = 4.5 V | 3.15  |          | 3.15  |          | V    |
|                 |                                    | V <sub>CC</sub> = 5.5 V | 3.85  |          | 3.85  |          |      |
|                 |                                    | V <sub>CC</sub> = 3 V   |       | 0.9      |       | 0.9      |      |
| $V_{IL}$        | Low-level input voltage            | $V_{CC} = 4.5V$         |       | 1.35     |       | 1.35     | V    |
|                 |                                    | V <sub>CC</sub> = 5.5 V |       | 1.65     |       | 1.65     |      |
| VI              | Input voltage                      |                         | 0     | $V_{CC}$ | 0     | $V_{CC}$ | V    |
| Vo              | Output voltage                     |                         | 0     | $V_{CC}$ | 0     | $V_{CC}$ | V    |
|                 |                                    | V <sub>CC</sub> = 3 V   |       | -12      |       | -12      |      |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 4.5 V |       | -24      |       | -24      | mA   |
|                 |                                    | V <sub>CC</sub> = 5.5 V |       | -24      |       | -24      |      |
|                 |                                    | V <sub>CC</sub> = 3 V   |       | 12       |       | 12       |      |
| $I_{OL}$        | Low-level output current           | V <sub>CC</sub> = 4.5 V |       | 24       |       | 24       | mA   |
|                 |                                    | V <sub>CC</sub> = 5.5 V |       | 24       |       | 24       |      |
| Δt/Δν           | Input transition rise or fall rate | -                       |       | 8        |       | 8        | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     |                         | -55   | 125      | -40   | 85       | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED       | TEST COMPLICATE                         | \ ,             | T,   | <sub>A</sub> = 25°C | SN54AC37 | 4 SN | 174AC374 |      |
|-----------------|---|-----------------|------|---------------------|----------|------|----------|------|
| PARAMETER       | TEST CONDITIONS                         | v <sub>cc</sub> | MIN  | TYP MAX             | MIN MA   | X N  | IIN MAX  | UNIT |
|                 |   | 3 V             | 2.9  |                     | 2.9      | 2    | 2.9      |      |
|                 | $I_{OH} = -50 \mu A$                    | 4.5 V           | 4.4  |                     | 4.4      |      | 4.4      |      |
| $V_{OH}$        |   | 5.5 V           | 5.4  |                     | 5.4      |      | 5.4      | V    |
| VOH             | $I_{OH} = -12 \text{ mA}$               | 3 V             | 2.56 |                     | 2.4      | 2    | 46       | V    |
|                 |   | 4.5 V           | 3.86 |                     | 3.7      | 3    | 76       |      |
|                 | I <sub>OH</sub> = -24 mA                | 5.5 V           | 4.86 |                     | 4.7      | 4    | 76       |      |
|                 |   | 3 V             |      | 0.1                 | (        | .1   | 0.1      |      |
|                 | I <sub>OL</sub> = 50 μA                 | 4.5 V           |      | 0.1                 | (        | .1   | 0.1      |      |
| .,              |   | 5.5 V           |      | 0.1                 | (        | .1   | 0.1      | V    |
| V <sub>OL</sub> | I <sub>OL</sub> = 12 mA                 | 3 V             |      | 0.36                | (        | .5   | 0.44     | V    |
|                 | J 04 mA                                 | 4.5 V           |      | 0.36                | (        | .5   | 0.44     |      |
|                 | I <sub>OL</sub> = 24 mA                 | 5.5 V           |      | 0.36                | (        | .5   | 0.44     |      |
| I <sub>I</sub>  | $V_I = V_{CC}$ or GND                   | 5.5 V           |      | ±0.1                |          | ±1   | ±1       | μΑ   |
| I <sub>OZ</sub> | V <sub>O</sub> = V <sub>CC</sub> or GND | 5.5 V           |      | ±0.25               |          | ±5   | ±2.5     | μΑ   |
| Icc             | $V_I = V_{CC}$ or GND, $I_O = 0$        | 5.5 V           |      | 4                   |          | 30   | 40       | μΑ   |
| C <sub>i</sub>  | $V_I = V_{CC}$ or GND                   | 5 V             |      | 4.5                 |          |      |          | pF   |

### SN54AC374, SN74AC374 OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

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## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

|                    |                                 | $T_A = 2$ | T <sub>A</sub> = 25°C |     | C374 | SN74A | C374 | LIMIT |
|--------------------|---------------------------------|-----------|-----------------------|-----|------|-------|------|-------|
|                    |                                 | MIN       | MAX                   | MIN | MAX  | MIN   | MAX  | UNIT  |
| f <sub>clock</sub> | Clock frequency                 |           | 60                    |     | 60   |       | 60   | MHz   |
| t <sub>w</sub>     | Pulse duration, CLK high or low | 5.5       |                       | 6.5 |      | 6     |      | ns    |
| t <sub>su</sub>    | Setup time, data before CLK↑    | 5.5       |                       | 6.5 |      | 6     |      | ns    |
| t <sub>h</sub>     | Hold time, data after CLK↑      | 1         |                       | 1   |      | 1     |      | ns    |

## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

|                    |                                 | $T_A = 2$ | T <sub>A</sub> = 25°C |     | C374 | SN74AC374 |     | LINUT |
|--------------------|---------------------------------|-----------|-----------------------|-----|------|-----------|-----|-------|
|                    |                                 | MIN       | MAX                   | MIN | MAX  | MIN       | MAX | UNIT  |
| f <sub>clock</sub> | Clock frequency                 |           | 100                   |     | 95   |           | 100 | MHz   |
| t <sub>w</sub>     | Pulse duration, CLK high or low | 4         |                       | 5   |      | 4.5       |     | ns    |
| t <sub>su</sub>    | Setup time, data before CLK↑    | 4         |                       | 5   |      | 4.5       |     | ns    |
| t <sub>h</sub>     | Hold time, data after CLK↑      | 1.5       |                       | 1.5 |      | 1.5       |     | ns    |

## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

|                  | _       |          | _   |                       |      | 1   |           | 1   |      | 1     |
|------------------|---------|----------|-----|-----------------------|------|-----|-----------|-----|------|-------|
| DADAMETED        | то      | то       | T,  | T <sub>A</sub> = 25°C |      |     | SN54AC374 |     | C374 | UNIT  |
| PARAMETER        | (INPUT) | (OUTPUT) | MIN | TYP                   | MAX  | MIN | MAX       | MIN | MAX  | CIVII |
| f <sub>max</sub> |         |          | 60  | 110                   |      | 60  |           | 60  |      | MHz   |
| t <sub>PLH</sub> | 0114    | •        | 3   | 11                    | 13.5 | 3   | 16.5      | 1.5 | 15.5 |       |
| t <sub>PHL</sub> | CLK     | Q        | 2.5 | 10                    | 12.5 | 3   | 15        | 2   | 14   | ns    |
| t <sub>PZH</sub> | OF.     | •        | 3   | 9.5                   | 11.5 | 1   | 14        | 1.5 | 13   |       |
| t <sub>PZL</sub> | ŌĒ      | Q        | 3.5 | 9                     | 11.5 | 1   | 14        | 1.5 | 13   | ns    |
| t <sub>PHZ</sub> | OF.     | 0        | 3   | 10.5                  | 12.5 | 1   | 16        | 2   | 14.5 | no    |
| $t_{PLZ}$        | ŌĒ      | Q        | 2   | 8                     | 11.5 | 1   | 13        | 1   | 12.5 | ns    |

## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

|                  | TO             | то       | T,  | <sub>A</sub> = 25°C | ;   | SN54A | C374 | SN74A | C374 |      |
|------------------|----------------|----------|-----|---------------------|-----|-------|------|-------|------|------|
| PARAMETER        | (INPUT)        | (OUTPUT) | MIN | TYP                 | MAX | MIN   | MAX  | MIN   | MAX  | UNIT |
| f <sub>max</sub> |                |          | 100 | 155                 |     | 95    |      | 100   |      | MHz  |
| t <sub>PLH</sub> | OLIV.          | ^        | 2.5 | 8                   | 9.5 | 3     | 12   | 1.5   | 10.5 |      |
| t <sub>PHL</sub> | CLK            | Q        | 2   | 7                   | 9   | 3     | 11   | 1.5   | 10   | ns   |
| t <sub>PZH</sub> | <del>0</del> 5 | 0        | 2   | 7                   | 8.5 | 1.5   | 10   | 1     | 9.5  |      |
| t <sub>PZL</sub> | ŌĒ             | Q        | 2   | 6.5                 | 8.5 | 1.5   | 10.5 | 1     | 9.5  | ns   |
| t <sub>PHZ</sub> | O.F.           | Q        | 2   | 8                   | 11  | 1.5   | 12.5 | 2     | 12.5 |      |
| t <sub>PLZ</sub> | ŌĒ             | ď        | 1.5 | 6.5                 | 8.5 | 1.5   | 10.5 | 1     | 10   | ns   |

#### operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

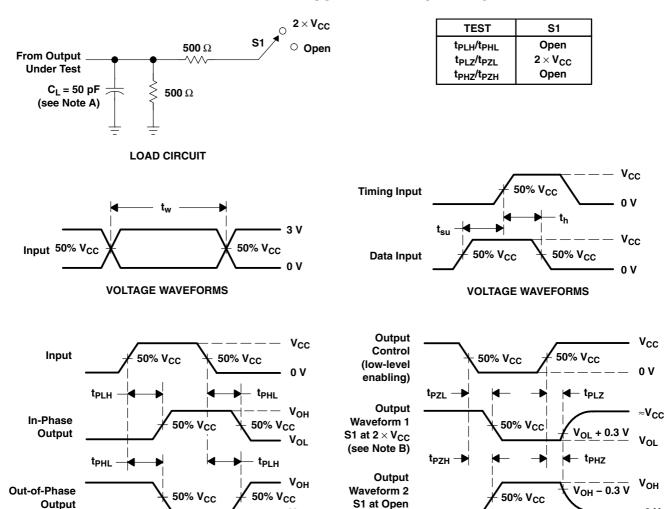
|                 | PARAMETER                     | TEST CONDITIONS                                 | TYP | UNIT |
|-----------------|-------------------------------|---|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | $C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$ | 40  | pF   |



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**VOLTAGE WAVEFORMS** 

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

**VOLTAGE WAVEFORMS** 

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_{O} = 50 \Omega$ ,  $t_{f} \leq 2.5 \text{ ns.}$

(see Note B)

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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#### **PACKAGING INFORMATION**

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan (2)        | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5)                | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|--------------------|--------------|--|---------|
| 5962-87694012A   | ACTIVE     | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type | -55 to 125   | 5962-<br>87694012A<br>SNJ54AC<br>374FK | Samples |
| 5962-8769401RA   | ACTIVE     | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type | -55 to 125   | 5962-8769401RA<br>SNJ54AC374J          | Samples |
| 5962-8769401SA   | ACTIVE     | CFP          | W                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type | -55 to 125   | 5962-8769401SA<br>SNJ54AC374W          | Samples |
| SN74AC374DBR     | ACTIVE     | SSOP         | DB                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM | -40 to 85    | AC374                                  | Samples |
| SN74AC374DW      | ACTIVE     | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM | -40 to 85    | AC374                                  | Samples |
| SN74AC374DWR     | ACTIVE     | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM | -40 to 85    | AC374                                  | Samples |
| SN74AC374N       | ACTIVE     | PDIP         | N                  | 20   | 20             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type | -40 to 85    | SN74AC374N                             | Samples |
| SN74AC374NSR     | ACTIVE     | SO           | NS                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM | -40 to 85    | AC374                                  | Samples |
| SN74AC374PW      | ACTIVE     | TSSOP        | PW                 | 20   | 70             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM | -40 to 85    | AC374                                  | Samples |
| SN74AC374PWR     | ACTIVE     | TSSOP        | PW                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM | -40 to 85    | AC374                                  | Samples |
| SNJ54AC374FK     | ACTIVE     | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type | -55 to 125   | 5962-<br>87694012A<br>SNJ54AC<br>374FK | Samples |
| SNJ54AC374J      | ACTIVE     | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type | -55 to 125   | 5962-8769401RA<br>SNJ54AC374J          | Samples |
| SNJ54AC374W      | ACTIVE     | CFP          | W                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type | -55 to 125   | 5962-8769401SA<br>SNJ54AC374W          | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54AC374, SN74AC374:

Catalog: SN74AC374

Military: SN54AC374

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device       | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AC374DBR | SSOP            | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2        | 7.5        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74AC374DWR | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74AC374NSR | SO              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |
| SN74AC374PWR | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |

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#### \*All dimensions are nominal

| <br>ui diirioriororio dio riorimidi |              |                 |      |      |             |            |             |
|-------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                              | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74AC374DBR                        | SSOP         | DB              | 20   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74AC374DWR                        | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74AC374NSR                        | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74AC374PWR                        | TSSOP        | PW              | 20   | 2000 | 356.0       | 356.0      | 35.0        |

## **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**



\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-87694012A | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| 5962-8769401SA | W            | CFP          | 20   | 1   | 506.98 | 26.16  | 6220   | NA     |
| SN74AC374DW    | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74AC374N     | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74AC374PW    | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| SNJ54AC374FK   | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| SNJ54AC374W    | W            | CFP          | 20   | 1   | 506.98 | 26.16  | 6220   | NA     |

## FK (S-CQCC-N\*\*)

### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



## W (R-GDFP-F20)

### CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

  D. Index point is provided on cap for terminal identification only.

  E. Falls within Mil—Std 1835 GDFP2—F20







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



## PW (R-PDSO-G20)

## PLASTIC SMALL OUTLINE



- All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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